



# Clock Buffer/Driver

## Features

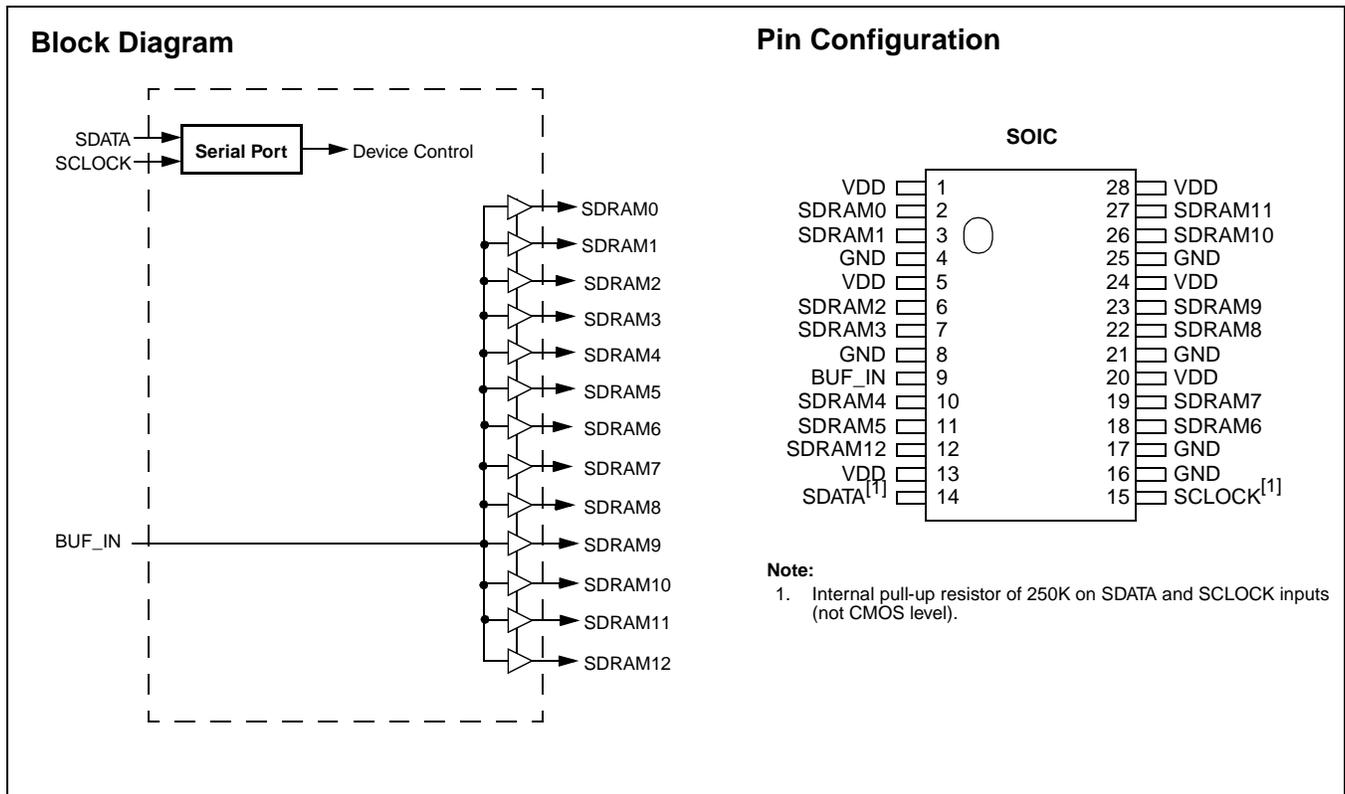
- Thirteen skew-controlled CMOS clock outputs (SDRAM0:12)
- Supports three SDRAM DIMMs
- Ideal for high-performance systems designed around Intel's latest chip set
- SMBus serial configuration interface
- Clock Skew between any two outputs is less than 250 ps
- 1- to 5-ns propagation delay
- DC to 133-MHz operation
- Single 3.3V supply voltage
- Low power CMOS design packaged in a 28-pin, 300-mil SOIC (Small Outline Integrated Circuit), 28-pin, 173-mil (Thin Shrink Small Outline Package), and 28-pin, 209-mil SSOP (Small Shrink Outline Package)

## Key Specifications

Supply Voltages: .....  $V_{DD} = 3.3V \pm 5\%$   
 Operating Temperature: .....  $0^{\circ}C$  to  $+70^{\circ}C$   
 Input Threshold: ..... 1.5V typical  
 Maximum Input Voltage: .....  $V_{DD} + 0.5V$   
 Input Frequency: ..... 0 to 133 MHz  
 BUF\_IN to SDRAM0:12 Propagation Delay: ..... 1.0 to 5.0 ns  
 Output Edge Rate: .....  $\geq 1.5$  V/ns  
 Output Clock Skew: .....  $\pm 250$  ps  
 Output Duty Cycle: ..... 45/55% worst case  
 Output Impedance: .....  $15\Omega$  typical  
 Output Type: ..... CMOS rail-to-rail

## Overview

The Cypress W40S11-23 is a low-voltage, thirteen-output clock buffer. Output buffer impedance is approximately  $15\Omega$ , which is ideal for driving SDRAM DIMMs.



**Pin Definitions**

Pin Name	Pin No.	Pin Type	Pin Description
SDRAM0:12	2, 3, 6, 7, 10, 11, 18, 19, 22, 23, 26, 27, 12	O	<b>SDRAM Outputs:</b> Provides buffered copy of BUF_IN. The propagation delay from a rising input edge to a rising output edge is 1 to 5 ns. All outputs are skew controlled to within $\pm 250$ ps of each other.
BUF_IN	9	I	<b>Clock Input:</b> This clock input has an input threshold voltage of 1.5V (typ).
SDATA	14	I/O	<b>SMBus Data Input:</b> Data should be presented to this input as described in the SMBus section of this data sheet. Internal 250-k $\Omega$ pull-up resistor.
SCLOCK	15	I	<b>SMBus Clock Input:</b> The SMBus data clock should be presented to this input as described in the SMBus section of this data sheet. Internal 250-k $\Omega$ pull-up resistor.
VDD	1, 5, 13, 20, 24, 28	P	<b>Power Connection:</b> Power supply for core logic and output buffers. Connected to 3.3V supply.
GND	4, 8, 16, 17, 21, 25	G	<b>Ground Connection:</b> Connect all ground pins to the common system ground plane.

**Functional Description**
**Output Drivers**

The W40S11-23 output buffers are CMOS type which deliver a rail-to-rail (GND to  $V_{DD}$ ) output voltage swing into a nominal

capacitive load. Thus output signaling is both TTL and CMOS level compatible. Nominal output buffer impedance is 15 $\Omega$ .

**Operation**

Data is written to the W40S11-23 in ten bytes of eight bits each. Bytes are written in the order shown in *Table 1*.

**Table 1. Byte Writing Sequence**

Byte Sequence	Byte Name	Bit Sequence	Byte Description
1	Slave Address	11010010	Commands the W40S11-23 to accept the bits in Data Bytes 0–6 for internal register configuration. Since other devices may exist on the same common serial data bus, it is necessary to have a specific slave address for each potential receiver. The slave receiver address for the W40S11-23 is 11010010. Register setting will not be made if the Slave Address is not correct (or is for an alternate slave receiver).
2	Command Code	Don't Care	Unused by the W40S11-23, bit values are ignored (Don't Care). This byte must be included in the data write sequence to maintain proper byte allocation. The Command Code Byte is part of the standard serial communication protocol and may be used when writing to another addressed slave receiver on the serial data bus.
3	Byte Count	Don't Care	Unused by the W40S11-23, bit values are ignored (Don't Care). This byte must be included in the data write sequence to maintain proper byte allocation. The Byte Count Byte is part of the standard serial communication protocol and may be used when writing to another addressed slave receiver on the serial data bus.
4	Data Byte 0	Refer to <i>Table 2</i>	The data bits in these bytes set internal W40S11-23 registers that control device operation. The data bits are only accepted when the Address Byte bit sequence is 11010010, as noted above. For description of bit control functions refer to <i>Table 2</i> .
5	Data Byte 1		
6	Data Byte 2		
7	Data Byte 3	Don't Care	Refer to Cypress Frequency Timing Generators.
8	Data Byte 4		
9	Data Byte 5		
10	Data Byte 6		

**Writing Data Bytes**

Each bit in the data bytes control a particular device function. Bits are written MSB (most significant bit) first, which is bit 7.

Table 2 gives the bit formats for registers located in Data Bytes 0–6.

**Table 2. Data Bytes 0–2 Serial Configuration Map<sup>[2]</sup>**

Bit(s)	Affected Pin		Control Function	Bit Control	
	Pin No.	Pin Name		0	1
<b>Data Byte 0 SDRAM Active/Inactive Register (1 = Enable, 0 = Disable)</b>					
7	11	SDRAM5	Clock Output Disable	Low	Active
6	10	SDRAM4	Clock Output Disable	Low	Active
5	N/A	Reserved	(Reserved)	-	-
4	N/A	Reserved	(Reserved)	-	-
3	7	SDRAM3	Clock Output Disable	Low	Active
2	6	SDRAM2	Clock Output Disable	Low	Active
1	3	SDRAM1	Clock Output Disable	Low	Active
0	2	SDRAM0	Clock Output Disable	Low	Active
<b>Data Byte 1 SDRAM Active/Inactive Register (1 = Enable, 0 = Disable)</b>					
7	27	SDRAM11	Clock Output Disable	Low	Active
6	26	SDRAM10	Clock Output Disable	Low	Active
5	23	SDRAM9	Clock Output Disable	Low	Active
4	22	SDRAM8	Clock Output Disable	Low	Active
3	N/A	Reserved	(Reserved)	-	-
2	N/A	Reserved	(Reserved)	-	-
1	19	SDRAM7	Clock Output Disable	Low	Active
0	18	SDRAM6	Clock Output Disable	Low	Active
<b>Data Byte 2 SDRAM Active/Inactive Register (1 = Enable, 0 = Disable)</b>					
7	N/A	Reserved	(Reserved)	-	-
6	12	SDRAM12	Clock Output Disable	Low	Active
5	N/A	Reserved	(Reserved)	--	--
4	N/A	Reserved	(Reserved)	--	--
3	N/A	Reserved	(Reserved)	--	--
2	N/A	Reserved	(Reserved)	--	--
1	N/A	Reserved	(Reserved)	--	--
0	N/A	Reserved	(Reserved)	--	--

**Note:**

- At power-up all SDRAM outputs are enabled and active. Program Reserved bits to a "0."

## How To Use the Serial Data Interface

### Electrical Requirements

Figure 1 illustrates electrical characteristics for the serial interface bus used with the W40S11-23. Devices send data over the bus with an open drain logic output that can (a) pull the bus line LOW, or (b) let the bus default to logic 1. The pull-up resistor on the bus (both clock and data lines) establish a default

logic 1. All bus devices generally have logic inputs to receive data.

Although the W40S11-23 is a receive-only device (no data write-back capability), it does transmit an “acknowledge” data pulse after each byte is received. Thus, the SDATA line can both transmit and receive data.

The pull-up resistor should be sized to meet the rise and fall times specified in AC parameters, taking into consideration total bus line capacitance.

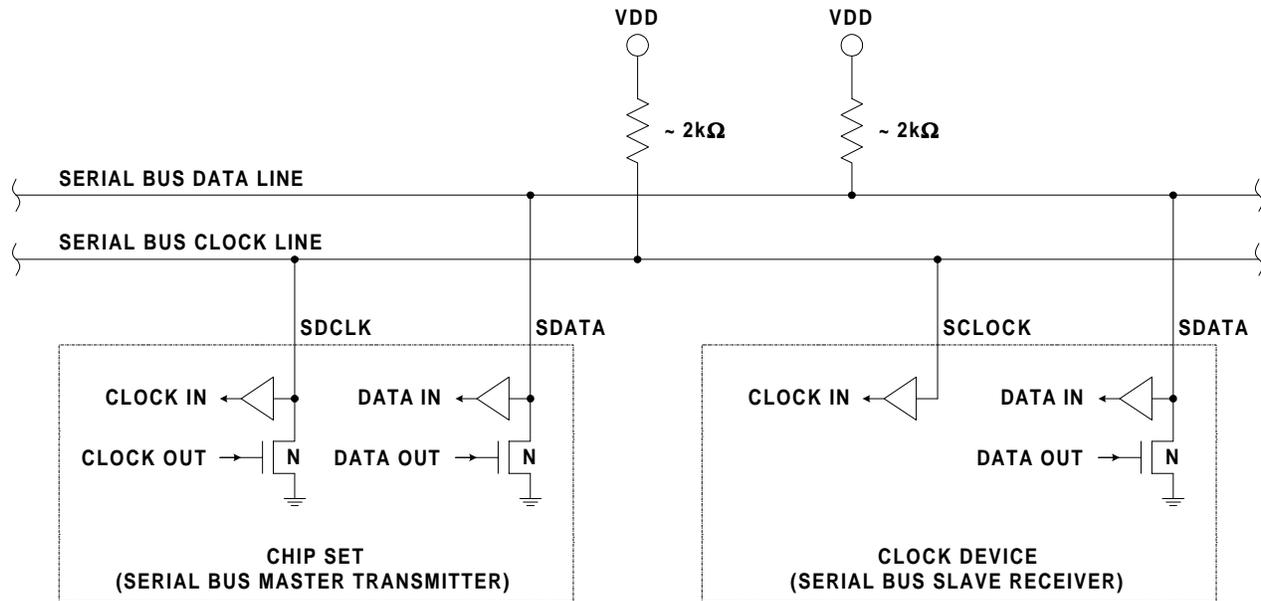


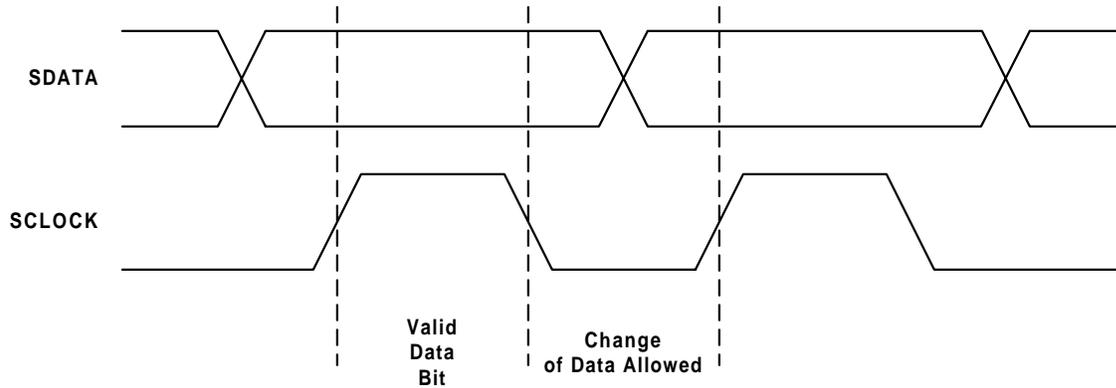
Figure 1. Serial Interface Bus Electrical Characteristics

**Signaling Requirements**

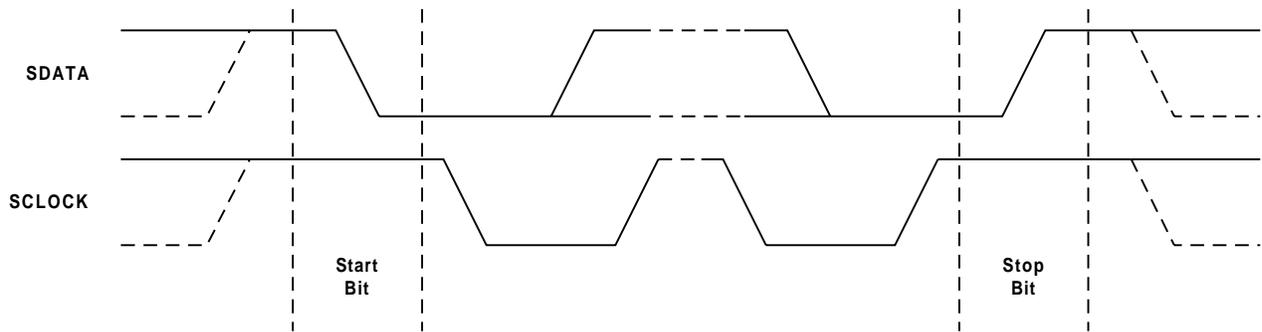
As shown in *Figure 2*, valid data bits are defined as stable logic 0 or 1 condition on the data line during a clock HIGH (logic 1) pulse. A transitioning data line during a clock HIGH pulse may be interpreted as a start or stop pulse (it will be interpreted as a start or stop pulse if the start/stop timing parameters are met).

A write sequence is initiated by a “start bit” as shown in *Figure 3*. A “stop bit” signifies that a transmission has ended.

As stated previously, the W40S11-23 sends an “acknowledge” pulse after receiving eight data bits in each byte as shown in *Figure 4*.



**Figure 2. Serial Data Bus Valid Data Bit**



**Figure 3. Serial Data Bus Start and Stop Bit**

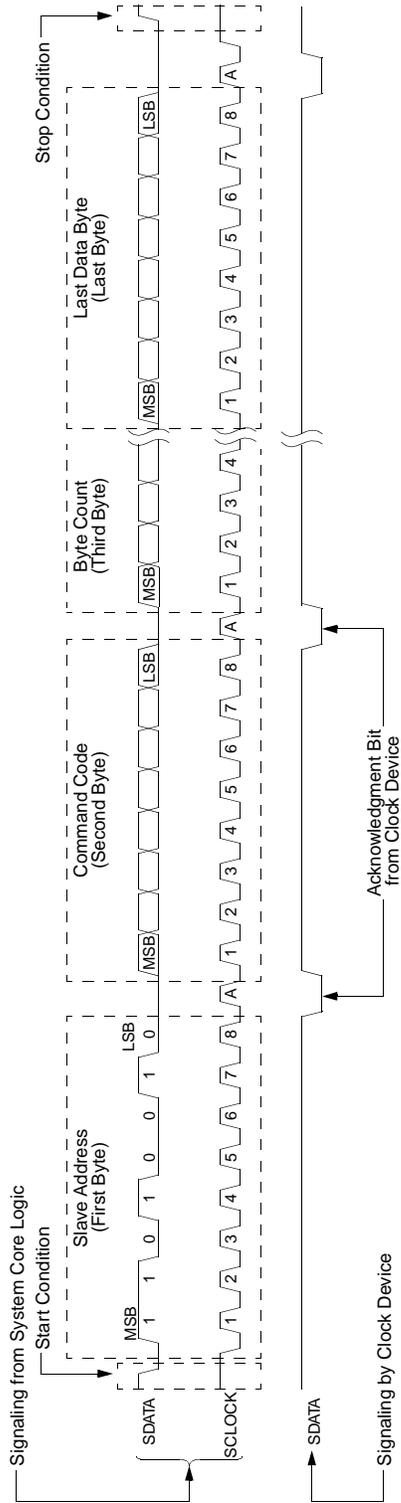


Figure 4. Serial Data Bus Write Sequence

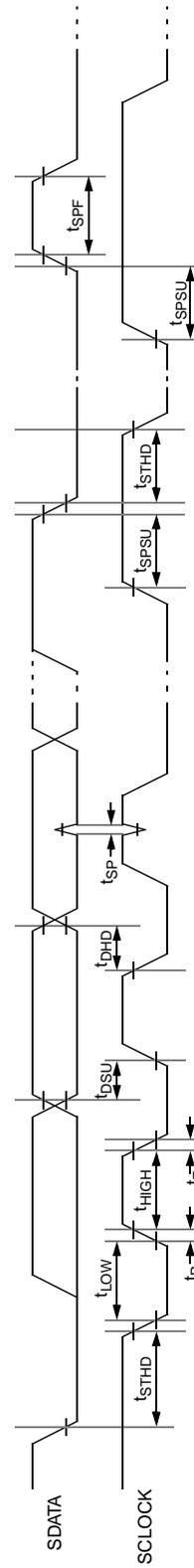


Figure 5. Serial Data Bus Timing Diagram

### Absolute Maximum Ratings

Stresses greater than those listed in this table may cause permanent damage to the device. These represent a stress rating only. Operation of the device at these or any other conditions

above those specified in the operating sections of this specification is not implied. Maximum conditions for extended periods may affect reliability.

Parameter	Description	Rating	Unit
$V_{DD}, V_{IN}$	Voltage on any pin with respect to GND	-0.5 to +7.0	V
$T_{STG}$	Storage Temperature	-65 to +150	°C
$T_A$	Operating Temperature	0 to +70	°C
$T_B$	Ambient Temperature under Bias	-55 to +125	°C

### DC Electrical Characteristics: $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$ , $V_{DD} = 3.3\text{V} \pm 5\%$

Parameter	Description	Test Condition/Comments	Min.	Typ.	Max.	Unit
$I_{DD}$	3.3V Supply Current	BUF_IN = 100 MHz			250	mA
<b>Logic Inputs</b>						
$V_{IL}$	Input Low Voltage		GND-0.3		0.8	V
$V_{IH}$	Input High Voltage		2.0		$V_{DD}+0.5$	V
$I_{ILEAK}$	Input Leakage Current, BUF_IN		-5		+5	$\mu\text{A}$
$I_{ILEAK}$	Input Leakage Current <sup>[3]</sup>		-20		+5	$\mu\text{A}$
<b>Logic Outputs (SDRAM0:12)</b>						
$V_{OL}$	Output Low Voltage	$I_{OL} = 1 \text{ mA}$			50	mV
$V_{OH}$	Output High Voltage	$I_{OH} = -1 \text{ mA}$	3.1			V
$I_{OL}$	Output Low Current	$V_{OL} = 1.5\text{V}$	65	100	160	mA
$I_{OH}$	Output High Current	$V_{OH} = 1.5\text{V}$	70	110	185	mA
<b>Pin Capacitance/Inductance</b>						
$C_{IN}$	Input Pin Capacitance				5	pF
$C_{OUT}$	Output Pin Capacitance				6	pF
$L_{IN}$	Input Pin Inductance				7	nH

**Note:**

- SDATA and SCLOCK logic pins have 250-k $\Omega$  internal pull-up resistors.

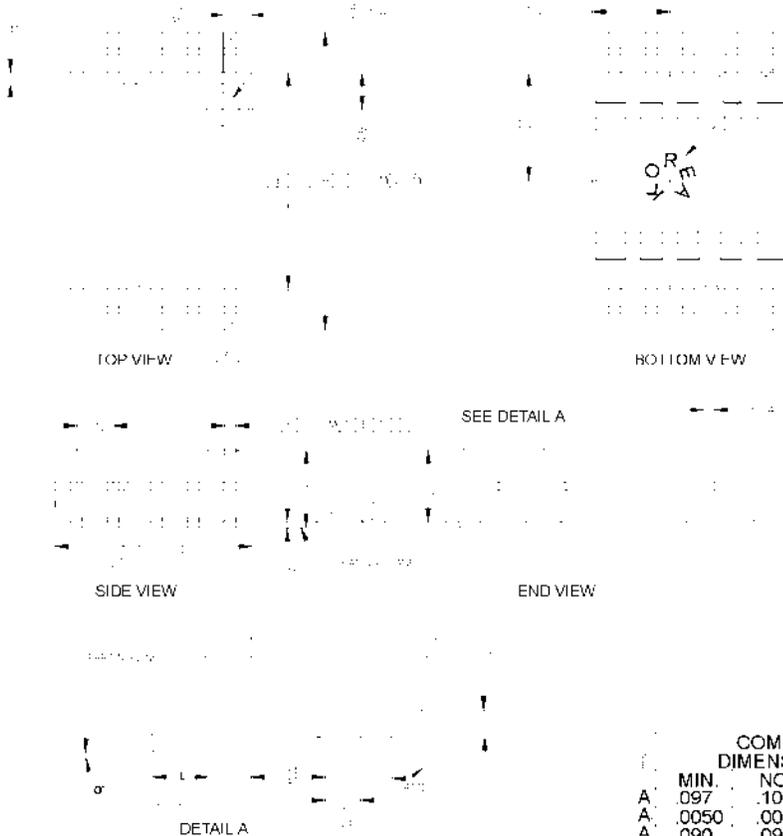
**AC Electrical Characteristics:**  $T_A = 0^\circ\text{C}$  to  $+70^\circ\text{C}$ ,  $V_{DD} = 3.3\text{V} \pm 5\%$  (Lump Capacitance Test Load = 30 pF)

Parameter	Description	Test Condition	Min	Typ	Max	Unit
$f_{IN}$	Input Frequency		0		133	MHz
$t_R$	Output Rise Edge Rate	Measured from 0.4V to 2.4V	1.5		4.0	V/ns
$t_F$	Output Fall Edge Rate	Measured from 2.4V to 0.4V	1.5		4.0	V/ns
$t_{SR}$	Output Skew, Rising Edges				250	ps
$t_{SF}$	Output Skew, Falling Edges				250	ps
$t_{EN}$	Output Enable Time		1.0		8.0	ns
$t_{DIS}$	Output Disable Time		1.0		8.0	ns
$t_{PR}$	Rising Edge Propagation Delay		1.0		5.0	ns
$t_{PF}$	Falling Edge Propagation Delay		1.0		5.0	ns
$t_D$	Duty Cycle	Measured at 1.5V	45		55	%
$Z_o$	AC Output Impedance			15		$\Omega$
$t_{PR}$	Rising Edge Propagation Delay		1.0		5.0	ns

**Ordering Information**

Ordering Code	Freq. Mask Code	Package Name	Package Type
W40S11	-23	G X H	28-pin SOIC (300 mils) 28-pin TSSOP (173 mil) 28-pin SSOP (209 mil)

Document #: 38-00793-\*B

**Package Diagrams**
**28-Pin Small Outline Integrated Circuit (SOIC, 0.300 inch)**

**NOTES.**

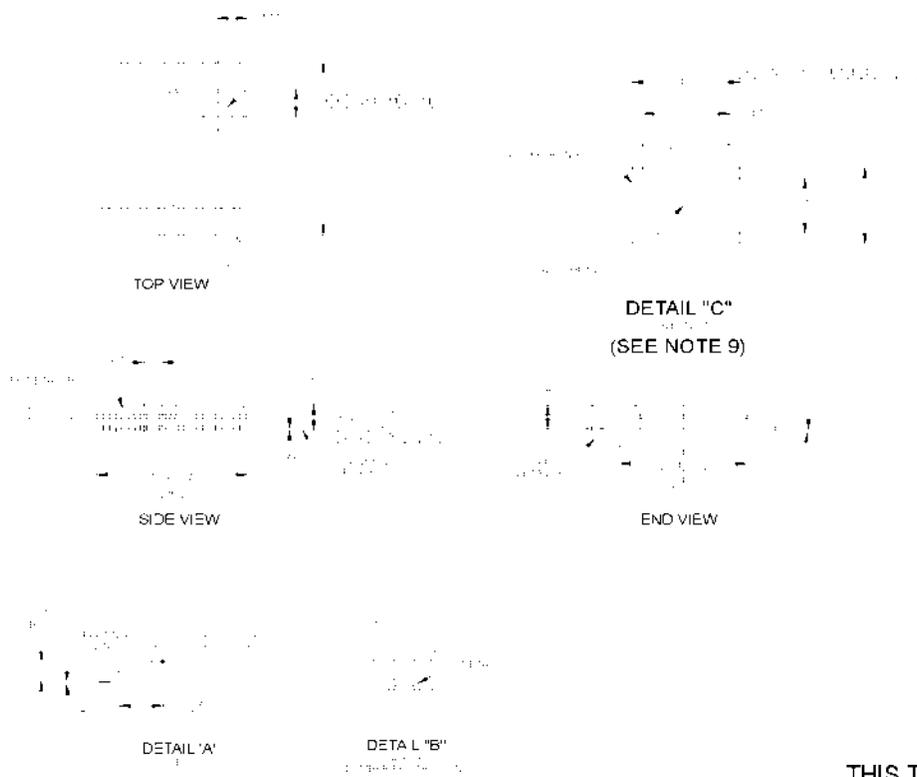
1. MAXIMUM LEAD THICKNESS ALLOWABLE IS .025
2. DIMENSIONING & TOLERANCES PER ANSI Y14.5M - 1982
3. "T" IS A REFERENCE DATUM
4. "D" & "E" ARE REFERENCE DATUMS AND DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS, BUT DOFS INCLUDE MOLD MISMATCH AND ARE MEASURED AT THE MOLD PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
5. "L" IS THE LENGTH OF TERMINAL FOR SOLDERING TO A SUBSTRATE
6. "N" IS THE NUMBER OF TERMINAL POSITIONS
7. TERMINAL POSITIONS ARE SHOWN FOR REFERENCE ONLY
8. FORMED LEADS SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITHIN .003 INCHES AT SEATING PLANE.
9. COUNTRY OF ORIGIN LOCATION AND EJECTOR PIN ON PACKAGE BOTTOM IS OPTIONAL AND DEPEND ON ASSEMBLY LOCATION
10. THE POCKETS ON THE BOTTOM ARE OPTIONAL
11. CONTROLLING DIMENSION INCHES

**THIS TABLE IN INCHES**

COMMON DIMENSIONS	NOTE VARIATIONS			3 D			5 N
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
A	.097	.101	.104	AA	.402	.407	.412
A'	.0050	.009	.0115	AB	.451	.456	.461
A'	.090	.092	.094	AC	.500	.505	.510
B	.014	.016	.019	AD	.602	.607	.612
C	.0091	.010	.0125	AE	.701	.706	.711
D	SEE VARIATIONS			3			
E	.292	.296	.299				
e	.050 BSC						
H	.400	.406	.410				
h	.010	.013	.016				
L	.024	.032	.040				
N	SEE VARIATIONS			5			
N	0°	5°	8°				
X	.085	.093	.100				

**THIS TABLE IN MILLIMETERS**

COMMON DIMENSIONS	NOTE VARIATIONS			3 D			5 N
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
A	2.46	2.56	2.64	AA	10.21	10.34	10.46
A'	0.127	0.22	0.29	AB	11.46	11.58	11.71
A'	2.29	2.34	2.39	AC	12.70	12.83	12.95
B	0.35	0.41	0.48	AD	15.29	15.42	15.54
C	0.23	0.25	0.32	AE	17.81	17.93	18.06
D	SEE VARIATIONS			3			
E	7.42	7.52	7.59				
e	.127 BSC						
H	10.16	10.31	10.41				
h	0.25	0.33	0.41				
L	0.61	0.81	1.02				
N	SEE VARIATIONS			5			
N	0°	5°	8°				
X	2.16	2.36	2.54				

**Package Diagrams (continued)**
**28-Pin Thin Shrink Small Outline Package (TSSOP, 173-mil)**


**NOTES**

1. DIMENSIONS ARE IN MILLIMETERS UNLESS OTHERWISE SPECIFIED.

2. DIMENSIONS IN PARENTHESES ARE FOR REFERENCE ONLY.

3. DIMENSIONS IN SQUARE BRACKETS ARE FOR REFERENCE ONLY.

4. DIMENSIONS IN BRACKETS ARE FOR REFERENCE ONLY.

5. DIMENSIONS IN BRACKETS ARE FOR REFERENCE ONLY.

6. DIMENSIONS IN BRACKETS ARE FOR REFERENCE ONLY.

7. DIMENSIONS IN BRACKETS ARE FOR REFERENCE ONLY.

8. DIMENSIONS IN BRACKETS ARE FOR REFERENCE ONLY.

9. DIMENSIONS IN BRACKETS ARE FOR REFERENCE ONLY.

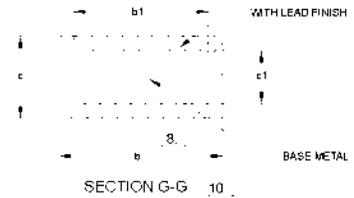
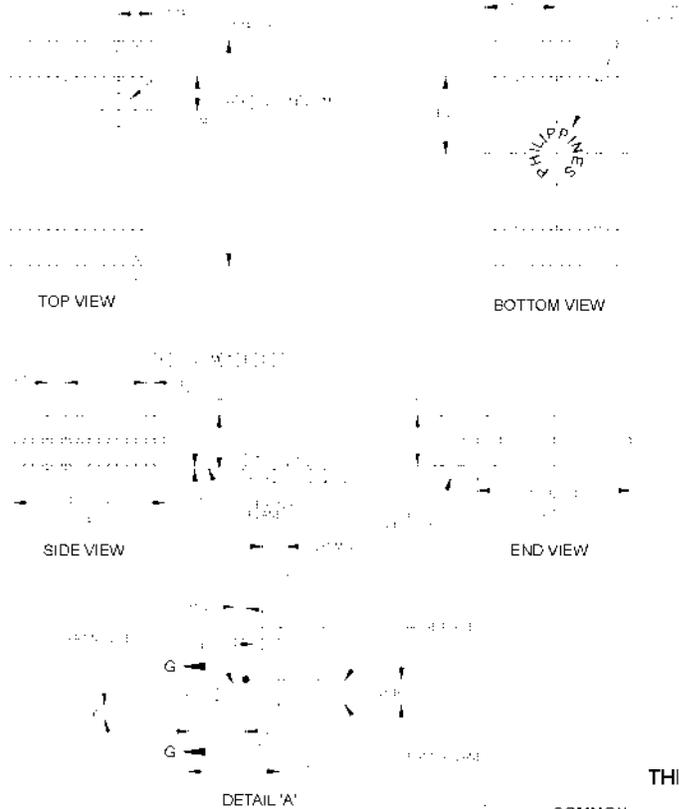
**THIS TABLE IN MILLIMETERS**

DIMENSION	COMMON DIMENSIONS			NOTE VARIATIONS	4 D			6 N
	MIN.	NOM.	MAX.		MIN.	NOM.	MAX.	
A			1.10	AA	2.90	3.00	3.10	8
A	0.05	0.10	0.15	AB	4.90	5.00	5.10	14
A	0.85	0.90	0.95	AC	4.90	5.00	5.10	16
b	0.19		0.30	AD	6.40	6.50	6.60	20
b1	0.19	0.22	0.25	AE	7.70	7.80	7.90	24
c	0.090		0.20	AF	9.60	9.70	9.80	28
c1	0.090	0.127	0.135					
D	SEE VARIATIONS							4
E	4.30	4.40	4.50					4
e	0.65 BSC							
H	6.25	6.40	6.50					
L	0.50	0.80	0.70					5
N	SEE VARIATIONS							6
θ	0°	4°	8°					

**THIS TABLE IN INCHES**

DIMENSION	COMMON DIMENSIONS			NOTE VARIATIONS	4 D			6 N
	MIN.	NOM.	MAX.		MIN.	NOM.	MAX.	
A			.0435	AA	.114	.118	.122	8
A	.002	.004	.006	AB	.193	.197	.201	14
A	.0335	.0354	.0374	AC	.193	.197	.201	16
b	.0075		.0118	AD	.252	.256	.260	20
b1	.0075	.0087	.0098	AE	.303	.307	.311	24
c	.0035		.0079	AF	.378	.382	.386	28
c1	.0035	.0050	.0053					
D	SEE VARIATIONS							4
E	.169	.173	.177					4
e	.0256 BSC							
H	.246	.252	.256					
L	.020	.024	.026					5
N	SEE VARIATIONS							6
θ	0°	4°	8°					

\*VARIATION AF IS DESIGNED BUT NOT TOOLED\*

**Package Diagrams (continued)**
**28-Pin Small Shrink Outline Package (SSOP, 209 mils)**

**NOTES**

1. MAXIMUM DIE THICKNESS ALLOWABLE IS 0.43mm (0.017 INCHES).
2. DIMENSIONING & TOLERANCES PER ANSI Y14.5M-1982.
3. 'T' IS A REFERENCE DATUM.
4. 'D' & 'F' ARE REFERENCE DATUMS AND DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS, BUT DO INCLUDE MOLD MISMATCH AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15mm PER SIDE.
5. DIMENSION IS THE LENGTH OF TERMINAL FOR SOLDERING TO A SUBSTRATE.
6. TERMINAL POSITIONS ARE SHOWN FOR REFERENCE ONLY.
7. FORMED LEADS SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITHIN 0.08mm AT SEATING PLANE.
8. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13mm TOTAL IN EXCESS OF a DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION b BY MORE THAN 0.07mm AT LEAST MATERIAL CONDITION.
9. CONTROL LING DIMENSIONS: MILLIMETERS.
10. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 AND 0.25mm FROM LEAD TIPS.
11. THIS PACKAGE OUTLINE DRAWING COMPLIES WITH JEDEC SPECIFICATION NO. MO-150 FOR THE LEAD COUNTS SHOWN.

**THIS TABLE IN MILLIMETERS**

	COMMON DIMENSIONS			NOTE VARIATIONS	4 D			6 N		
	MIN.	NOM.	MAX.		MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	1.73	1.85	1.95	AA	6.07	6.20	6.33	14		
A	0.05	0.13	0.21	AB	6.07	6.20	6.33	15		
A	1.68	1.73	1.78	AC	7.07	7.20	7.33	20		
b	0.25	-	0.38	AD	9.07	9.20	9.33	24		
b1	0.25	0.20	0.33	AE	10.07	10.20	10.33	28		
c	0.09	-	0.20	AF	10.07	10.20	10.33	30		
c1	0.09	0.15	0.16							
D	SEE VARIATIONS									
E	5.23	5.30	5.38							
e	0.65 BSC									
H	7.65	7.80	7.90							
L	0.63	0.75	0.95	5						
L1	1.25 REF									
N	SEE VARIATIONS			8						
	0°	4°	8°							
R	0.09	0.15								

VARIATION AF IS DESIGNED BUT NOT TOOLED

**THIS TABLE IN INCHES**

	COMMON DIMENSIONS			NOTE VARIATIONS	4 D			6 N		
	MIN.	NOM.	MAX.		MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.68	0.73	0.78	AA	239	244	249	14		
A	0.07	0.05	0.08	AB	259	244	249	15		
A	0.66	0.68	0.70	AC	278	284	289	20		
b	0.10	-	0.15	AD	358	323	328	24		
b1	0.10	0.12	0.13	AE	397	402	407	28		
c	0.04	-	0.08	AF	397	402	407	30		
c1	0.04	0.06	0.06							
D	SEE VARIATIONS									
F	205	209	212							
e	0.256 BSC									
H	301	307	311							
L	0.25	0.30	0.37	5						
L1	0.49 REF									
N	SEE VARIATIONS			8						
	0°	4°	8°							
R	0.04	0.06								